

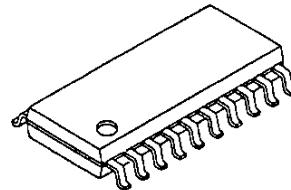
PCM-RF Signal Processing

For the availability of this product, please contact the sales office.**Description**

The CX20102 is a bipolar IC which has been developed for the processing of PCM audio RF signals of the 8 mm VTR, and consists of the following functions:

- Recording system : Limiter, and Area selector switch
- Playback system : Voltage follower for RF equalizer, Limiter, Tri-state TTL buffer, PLL, and D-FF

20-pin SOP (Plastic)

**Features**

- Single 5V ($5.0 \pm 0.25V$) power supply operation.
- Low power consumption (85mW typical in a REC mode, and 110 mW typical in a PB mode)
- Built-in power saving functions

Absolute Maximum Ratings (Ta=25°C)

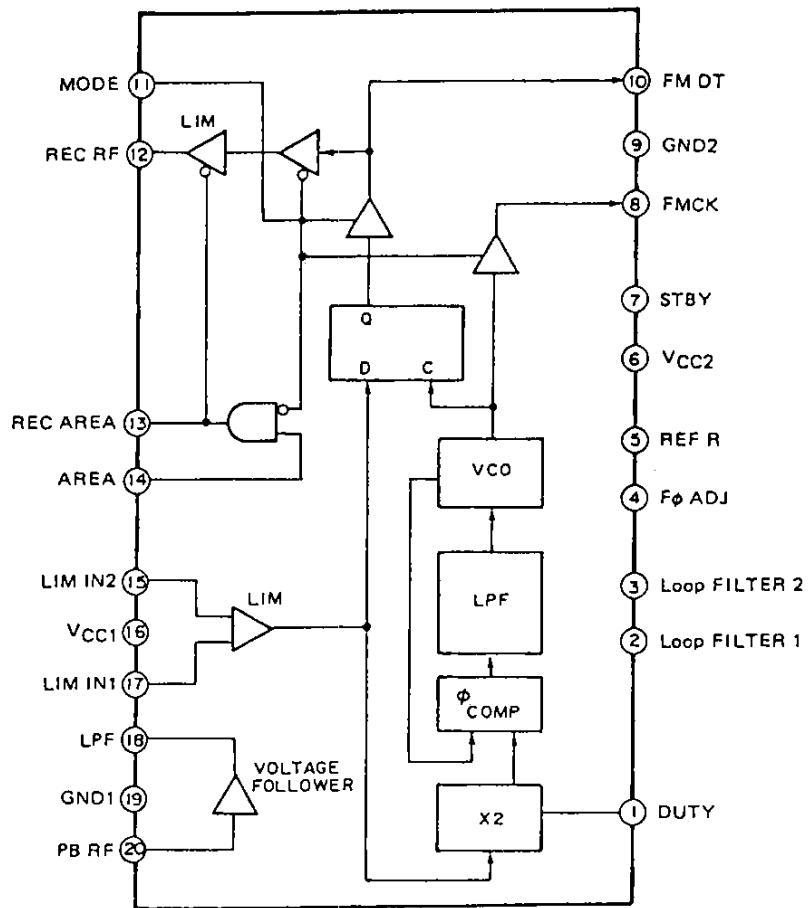
- Power supply voltage Vcc 10 V
- Operating temperature Topr -20 to +75 °C
- Storage temperature Tstg -55 to +150 °C
- Allowable power dissipation Po 690 mW

Recommended Operating Condition

4.75 to 5.25 V

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Block Diagram



Pin Description

No.	Name	Description
1	DUTY	Fine adjustment of the input waveform sampling phase Normally open
2	Loop filter 1	Connects an external loop filter time constant
3	Loop filter 2	Connects an external loop filter time constant
4	F ϕ ADJ	Adjusting pin of the VCO free running frequency
5	REF R	R externally attached VCO current source
6	Vcc2	Digital Vcc
7	STBY	Power saving control pin; standby at L (CMOS level)
8	FMCK	Clock output
9	GND2	Digital GND
10	FMDT	Data input/output
11	MODE	REC/PB selector pin (CMOS level)
12	REC RF	REC mode RF output (LIM OUT)
13	REC AREA	REC AREA output (CMOS level)
14	AREA	AREA input 2 (CMOS level)
15	LIM IN2	Limiter input
16	Vcc1	Analog Vcc
17	LIM IN1	Limiter input 1
18	LPF	Voltage follower output
19	GND1	Analog GND
20	RBRF	Voltage follower input

Electrical Characteristics

See Measuring Circuit Diagram 2

Ta=25°C, Vcc=5 V;

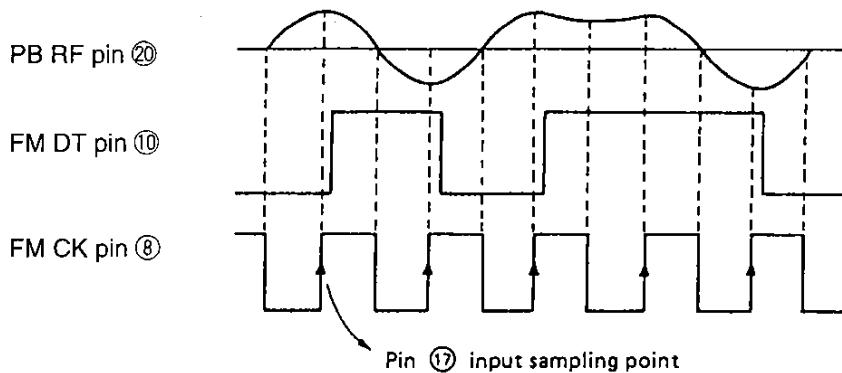
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
PB current consumption	I _{CCPB}	Pins ⑦ and ⑪ : H		19	25	mA
REC current consumption	I _{CCREC}	Pin ⑦ : H		16	20	mA
PB standby current	I _{CCST}			12	15	mA
Clock capture range	C.Rck	Pins ⑦ and ⑪ : H 1. With pin ① open, adjust the free running frequency at 11.5MHz 2. Input 50mV 11MHz and 12MHz from pin ① and perform measurement	11.0		12.0	MHz
Output level	V _{OH}		2.2			V
Pins ⑧ and ⑩	V _{OL}				0.8	V
Data clock delay time *1	t _{pd}		4		35	nS
Operating input voltage	V _{IN}		50			mVp-p
	V _{OH}	Pins ⑦ and ⑭ : H	3.5			V
Output level Pin ⑬	V _{OL}	Pins ⑦ : H or Pins ⑦, ⑭ and ⑪ : H or Pins ⑦ and ⑪ : H			1.5	V
Input current	I _{IH}	Input voltage: 4V		120	200	μA
Pins ⑦ and ⑭	I _{IL}	Input voltage: 0V	-2	0	+2	μA
Operating input voltage	V _{IH}		3.5			V
Pins ⑦ and ⑭	V _{IL}				1.5	V
Input current Pin ⑩	I _{IH}	Input voltage: 5V			60	μA
	I _{IL}	Input voltage: 0V	-2	0	2	μA
Operating input voltage	V _{IH}		2.5			V
Pin ⑩	V _{IL}				1.5	V
Input current Pin ⑪	I _{IH}	Input voltage: 3.5V		130	200	
	I _{IL}	Input voltage: 0V	-2	0	2	
Operating input voltage	V _{IH}		2.5			V
Pin ⑪	V _{IL}				0.8	V
Voltage follower gain	G _{VF}	Pins ⑦ and ⑪ : H Input: Pin ⑳ 6MHz, 0.6Vp-p Output: Pin ⑯	-1.5	0	1	dB
REC RF LIM output	V _{LIM}	Pins ⑦ and ⑭ : H Input: Pin ⑩ TTL level input Output: Pin ⑫	0.40	0.50	0.56	Vp-p

*1 For t_{pd} measurements, see Fig. 3 Timing Chart.**Truth Table**

Operation State	Pin 7	Pin 11	Pin 14
Power saving	L	X	X
PB	H	H	X
REC	H	L	H
REC standby	H	L	L

X: Don't care

**Fig. 1 Operating description
PB**



REC, REC STBY

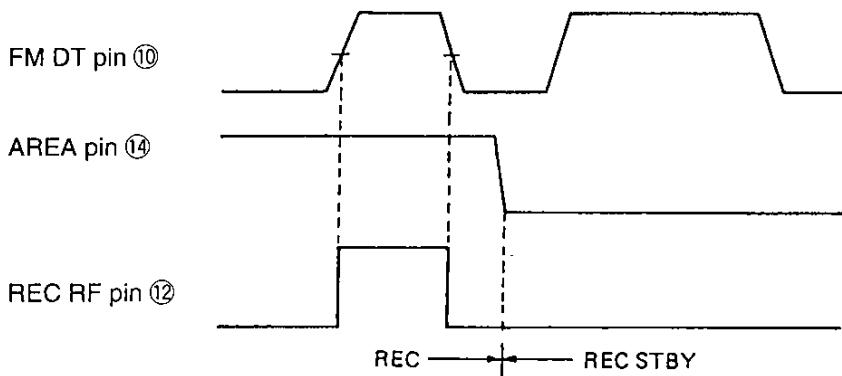


Fig. 2 Electrical characteristics measuring circuit

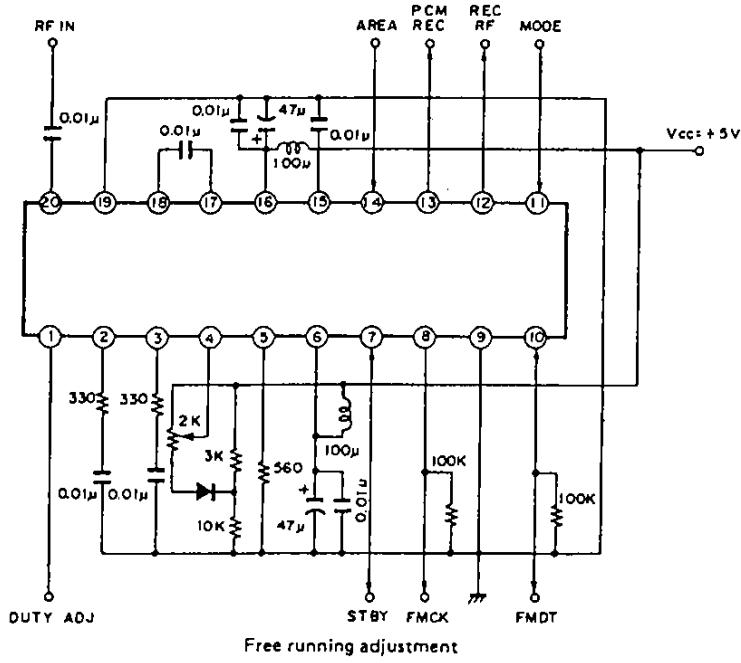
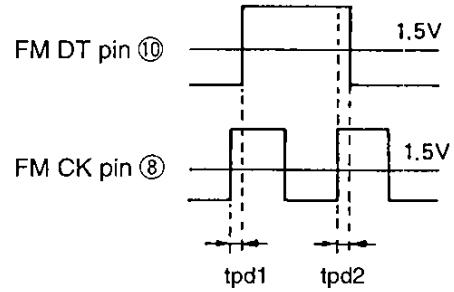


Fig. 3 tpd measurement



Standard Circuit Designing Data

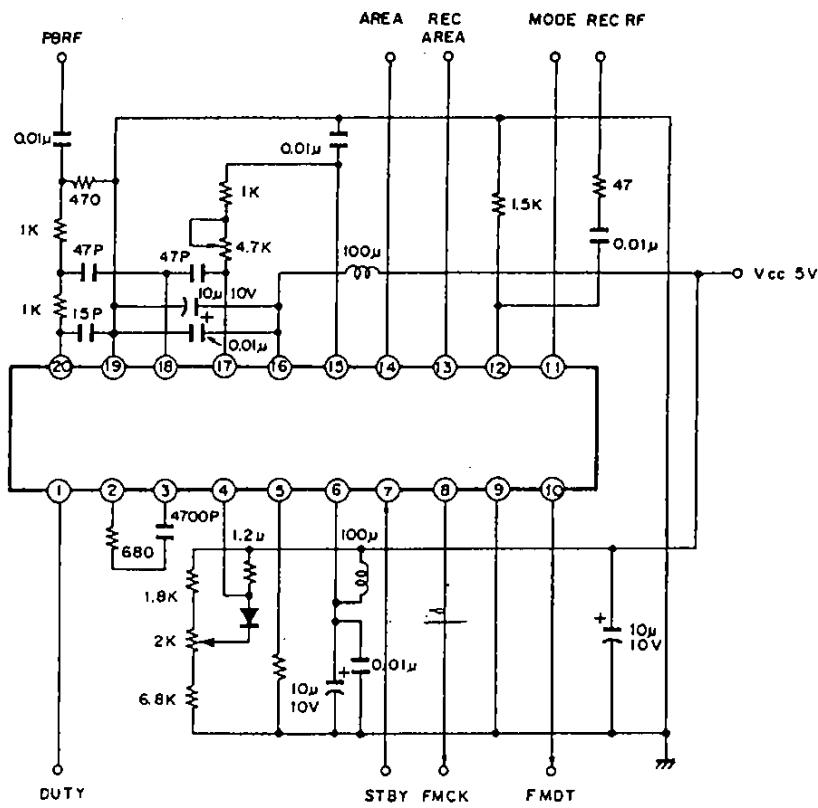
Standard pin voltage (DC): See Fig. 2

No.	Voltage	No.	Voltage
1	3.8V	11	5*V or 0V
2	4.3V	12	3.7 to 4.2V
3	4.3V	13	0 or 4.2V
4	4.85*V	14	5*V or 0V
5	0.2V	15	2.3V
6	5.0*V (Vcc)	16	5.0*V (Vcc)
7	5*V or 0V	17	2.3V
8	Clock output	18	2.3V
9	0* (GND)	19	0*V (GND)
10	Data output	20	2.3V

*: Externally applied

During PB mode (Pins ⑦ and ⑪: H)

Fig. 4 Application circuit



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Fig. 5 Free running frequency vs.
Power supply voltage

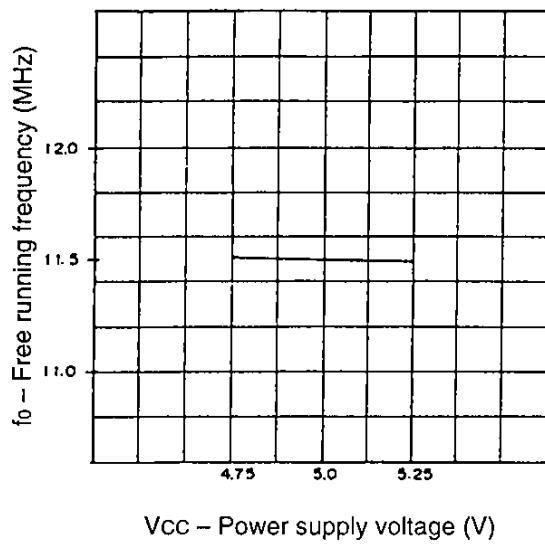


Fig. 6 Pin ⑦ current vs. Voltage

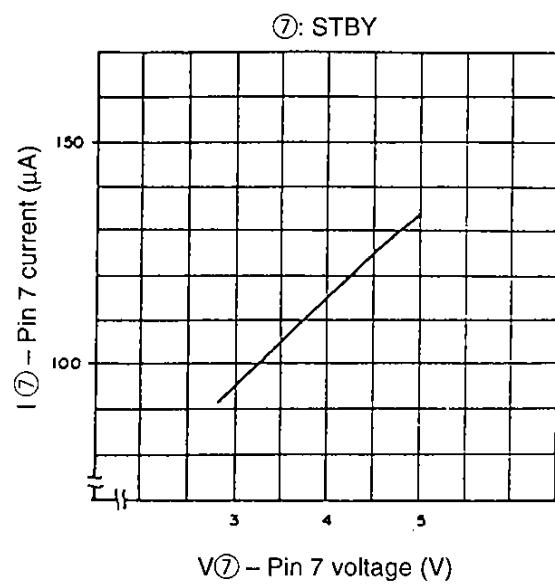


Fig. 7 Pin ⑪ current vs. Voltage

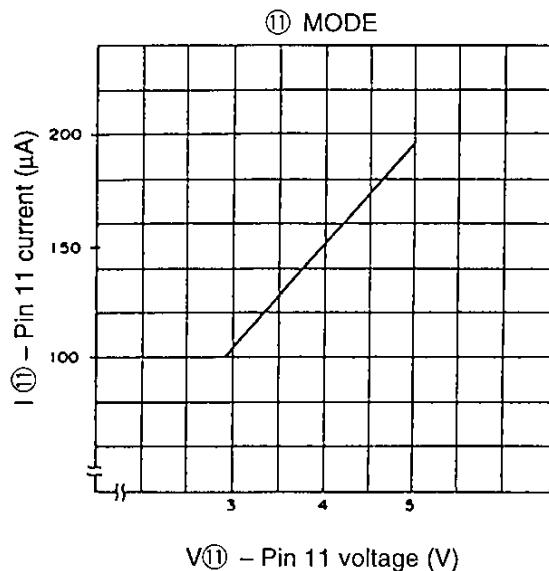
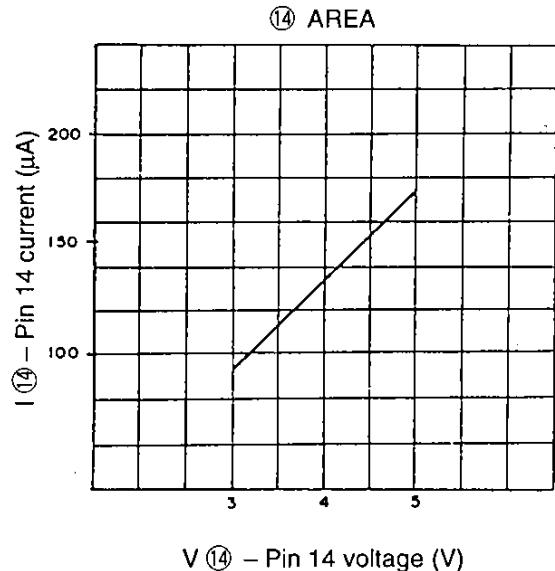
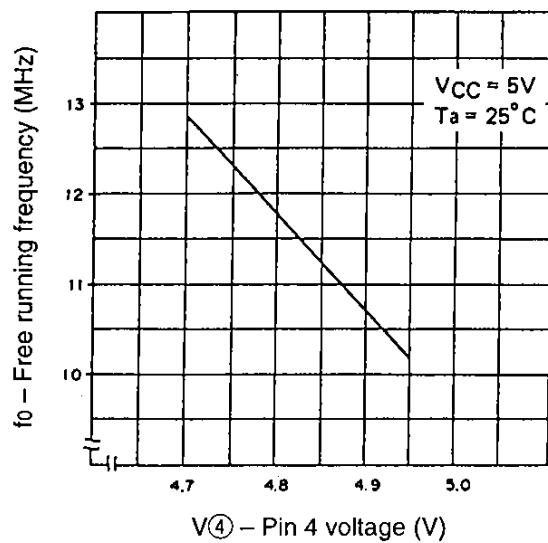


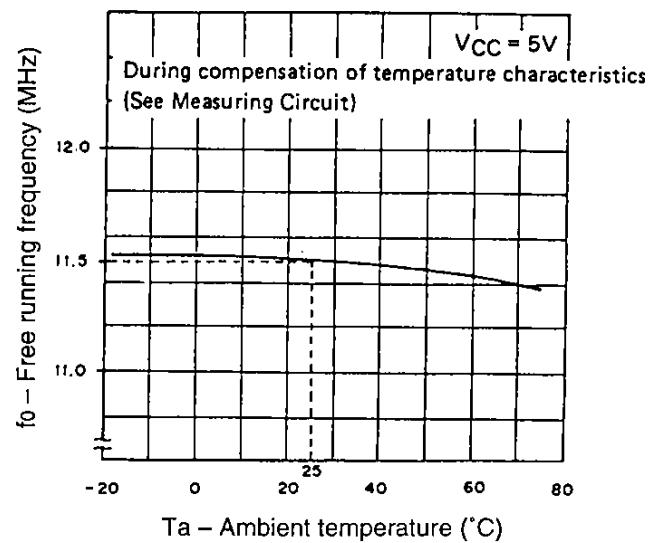
Fig. 8 Pin ⑭ current vs. Voltage



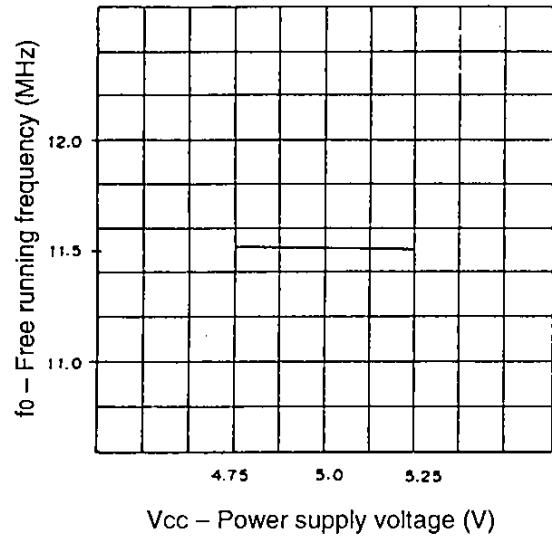
**Fig. 9 Free running frequency vs.
Pin ④ voltage**



**Fig. 10 Free running frequency vs.
Ambient temperature**

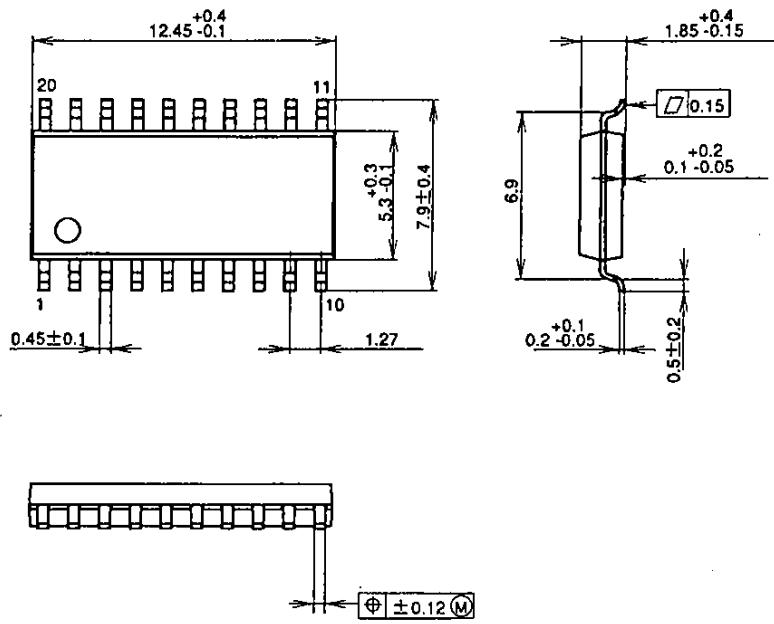


**Fig. 11 Free running frequency vs.
Power supply voltage**



Package Outline Unit : mm

20PIN SOP (PLASTIC) 300MIL



PACKAGE STRUCTURE

SONY CODE	SOP-20P-L01
EIAJ CODE	*SOP020-P-0300-A
JEDEC CODE	-----

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE WEIGHT	0.3g